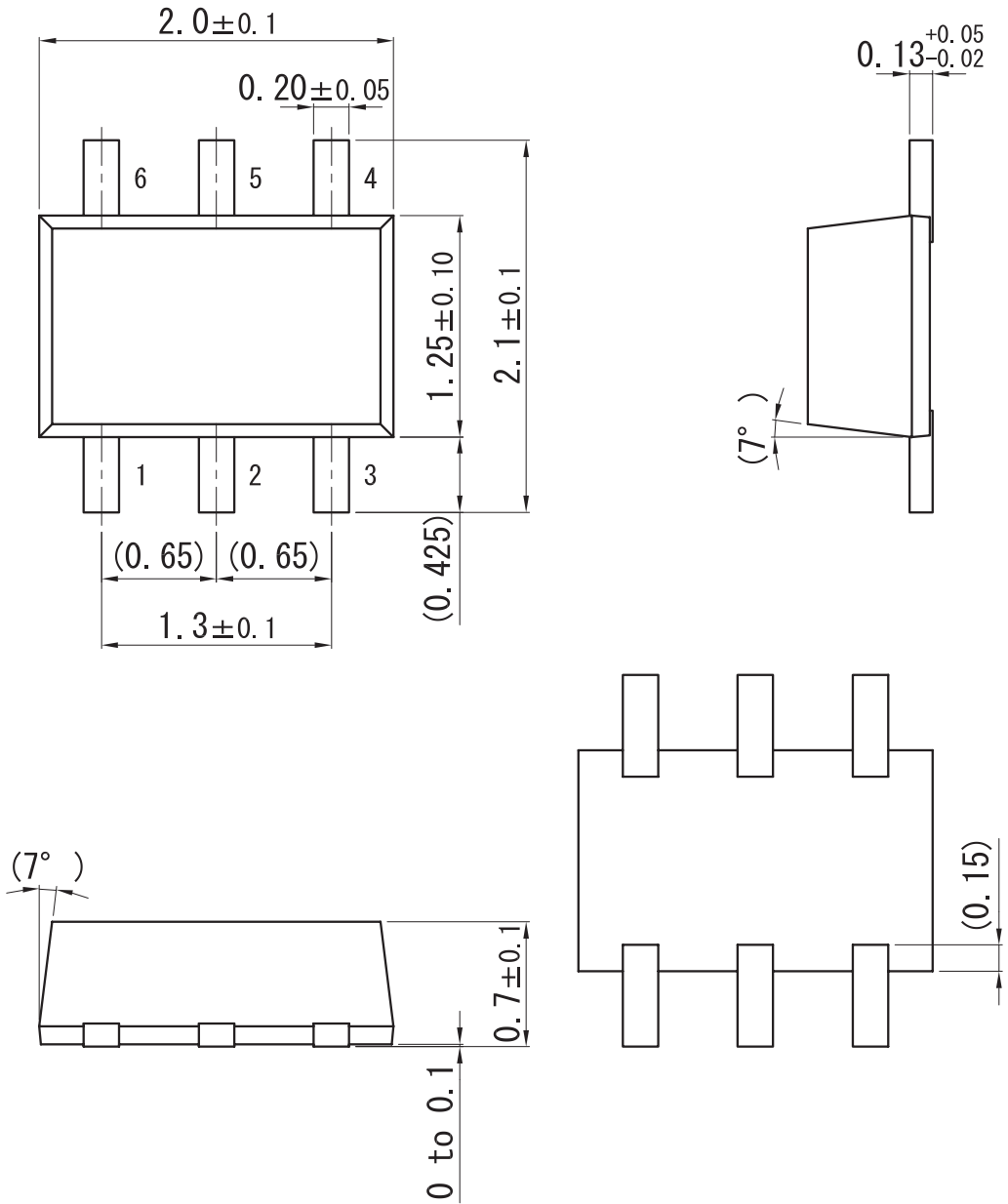
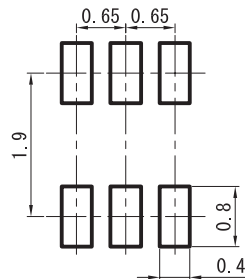


SMini6-F3-B

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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